

**Pb-free
HEAT**



1112C Series

Single Color High Brightness Type

Features

Package	1608 (h=0.5mm) Type, Milky White resin
Product features	<ul style="list-style-type: none"> • Outer Dimension 1.6 x 0.8 x 0.4mm (L x W x H) • Temperature range Storage Temperature : -40°C~100°C Operating Temperature : -40°C~85°C • Lead-free soldering compatible • RoHS compliant
Dominant wavelength	Blue : 470nm(UB) Green : 530nm(UG) Yellow : 590nm(FY) Orange : 605nm(FA) Red : 626nm(FR)
Half Intensity Angle	UB,UG : $\theta_x = 150 \text{ deg.}, \theta_y = 150 \text{ deg.}$ FY : $\theta_x = 132 \text{ deg.}, \theta_y = 149 \text{ deg.}$ FA,FR : $\theta_x = 130 \text{ deg.}, \theta_y = 150 \text{ deg.}$
Die materials	UB,UG : InGaN FY,FA,FR : AlGaInP
Rank grouping parameter	Sorted by luminous intensity and wavelength per rank taping
Assembly method	Auto pick & place machine (Auto Mounter)
Soldering methods	Reflow soldering, TTW (Through The Wave) soldering and manual soldering
Taping and reel	4,000pcs per reel in a 8mm width tape. (Standard) Reel diameter: ϕ 180mm
ESD	InGaN : 1kV(HBM), AlGaInP : More than 2kV(HBM)

Recommended Applications

Cellular Phone, Electric Household Appliances, Other General Applications

Color and Luminous Intensity

(Ta=25°C)

Part No.	Material	Emitted Color	Lens Color	Dominant Wavelength λd (nm)		Luminous Intensity I_v (mcd)		
				TYP.	I_F	MIN.	TYP.	I_F
				UB1112C	InGaN	Blue	Milky White	470
UG1111C	InGaN	Green	530	5	24	40		5
FY1112C	AlGaInP	Yellow	590	20	25	50		20
FA1112C	AlGaInP	Orange	605	20	25	50		20
FR1112C	AlGaInP	Red	626	20	25	45		20

Absolute Maximum Ratings

(Ta=25°C)

Item	Symbol	Absolute Maximum Ratings					Unit
		UB	UG	FY	FA	FR	
Power Dissipation	P_d	76	76	81	81	81	mW
Forward Current	I_F	20	20	30	30	30	mA
Pulse Forward Current ※1	I_{FRM}	48	48	100	100	100	mA
Derating (Ta=25°C or higher)	ΔI_F	0.28	0.28	0.43	0.43	0.43	mA/°C
	ΔI_{FRM}	0.69	0.69	1	1	1	mA/°C
Reverse Voltage	V_R	5	5	5	5	5	V
Operating Temperature	T_{opr}	-40~+85					°C
Storage Temperature	T_{stg}	-40~+100					°C

 ※1 I_{FRM} Measurement condition : $t_w \leq 1ms.$, Duty $\leq 1/20$ (FY,FA,FR : Duty $\leq 1/10$)

Electro-Optical Characteristics (UB,UG)

(Ta=25°C)

Item	Conditions	Symbol	Characteristics		Unit	
			UB	UG		
Forward Voltage	I _F =5mA	V _F	TYP.	2.9	2.9	V
			MAX.	3.2	3.3	
Reverse Current	V _R =5V	I _R	MAX.	100	100	μ A
Peak Wavelength	I _F =5mA	λ _p	TYP.	467	522	nm
Dominant Wavelength	I _F =5mA	λ _d	TYP.	470	530	nm
Spectral Line Half Width	I _F =5mA	Δλ	TYP.	26	30	nm
Half Intensity Angle	I _F =5mA	2θ 1/2	TYP.	150(θ x)	150(θ x)	deg.
				150(θ y)	150(θ y)	

Electro-Optical Characteristics (FY,FA,FR)

(Ta=25°C)

Item	Conditions	Symbol	Characteristics			Unit	
			FY	FA	FR		
Forward Voltage	I _F =20mA	V _F	TYP.	1.9	1.9	1.9	V
			MAX.	2.4	2.4	2.4	
Reverse Current	V _R =5V	I _R	MAX.	100	100	100	μ A
Peak Wavelength	I _F =20mA	λ _p	TYP.	592	609	635	nm
Dominant Wavelength	I _F =20mA	λ _d	TYP.	590	605	626	nm
Spectral Line Half Width	I _F =20mA	Δλ	TYP.	15	15	15	nm
Half Intensity Angle	I _F =20mA	2θ 1/2	TYP.	132(θ x)	130(θ x)	130(θ x)	deg.
				149(θ y)	150(θ y)	150(θ y)	

Luminous Intensity Rank

(Ta=25°C)

Intensity Tolerance each Rank (UB,UG) : +/- 10%

Rank	I _v (mcd)									
	UB		UG		FY		FA		FR	
	I _F =5mA		I _F =5mA		I _F =20mA		I _F =20mA		I _F =20mA	
	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.
A	6	10	24	38	25	50	25	50	25	50
B	10	16	38	61	35	70	35	70	35	70
C	16	25	61	98	50	100	50	100	50	100
D	25	40	98	157	70	140	70	140	70	140
E	40	-	157	-	100	200	100	200	100	200
F					140	-	140	-	140	-

Please contact our sales staff concerning rank designation.

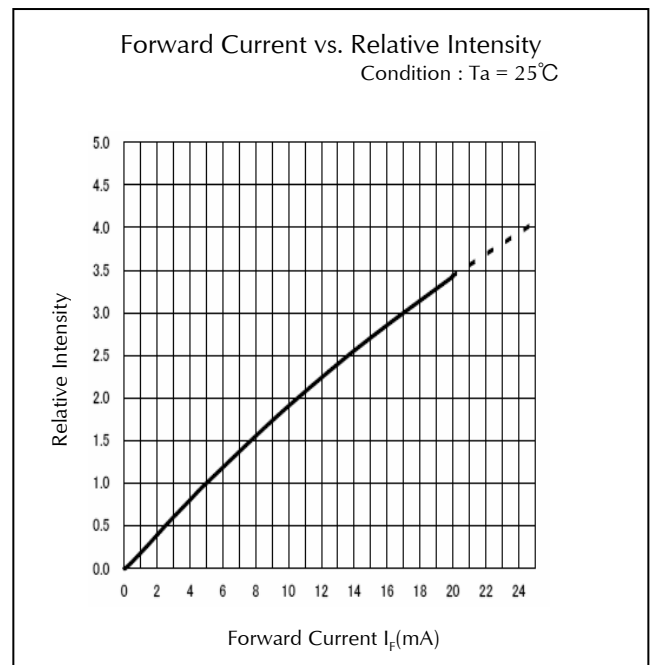
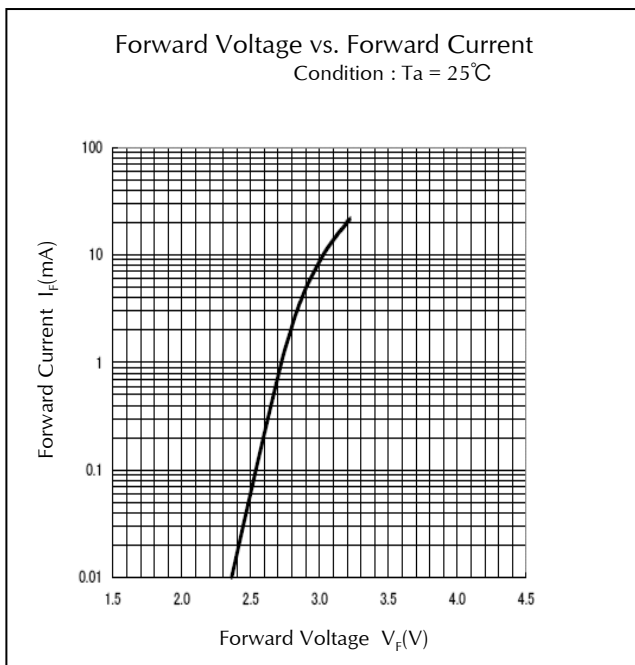
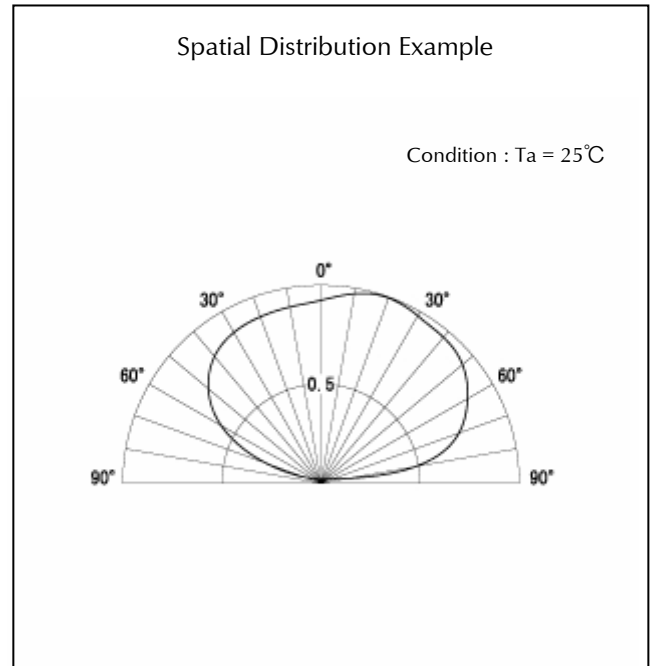
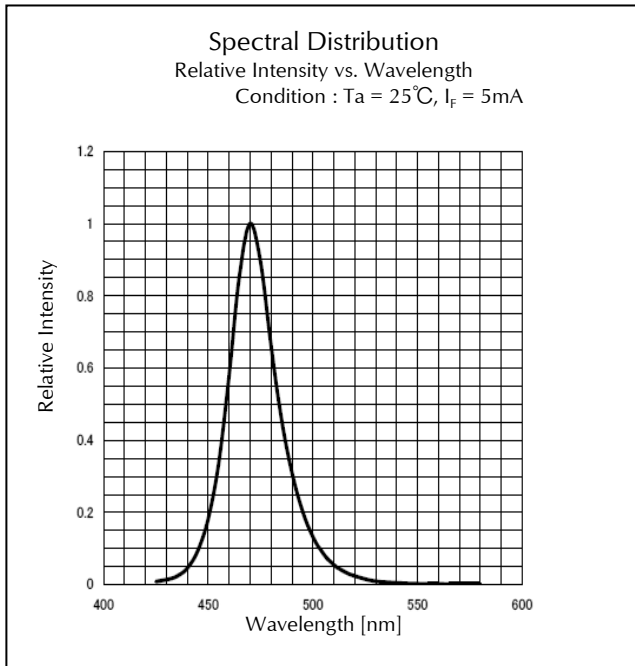
Color Tone Groups (λd)

(Ta=25°C)

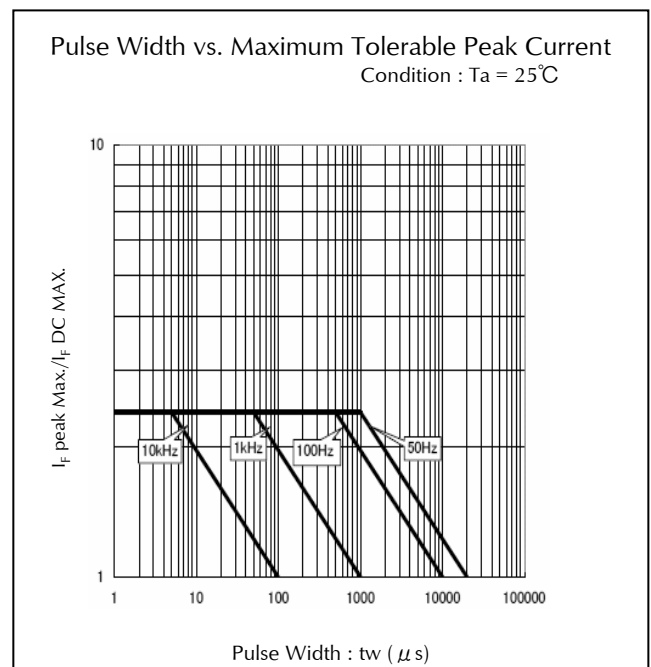
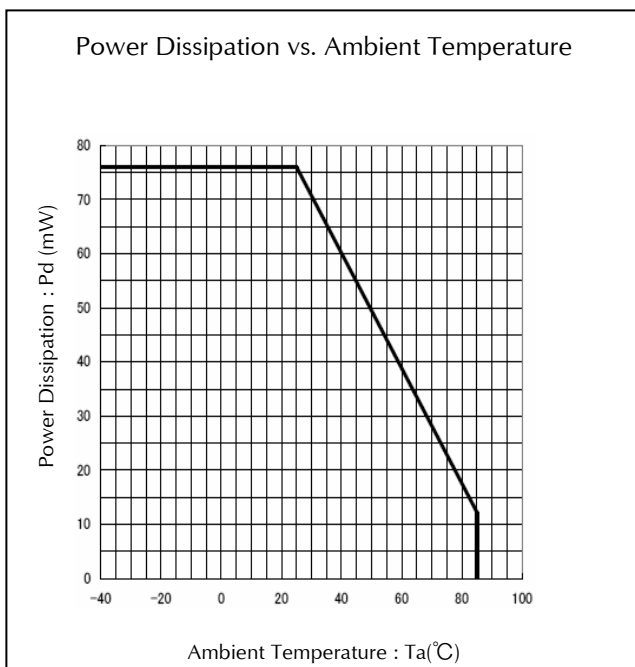
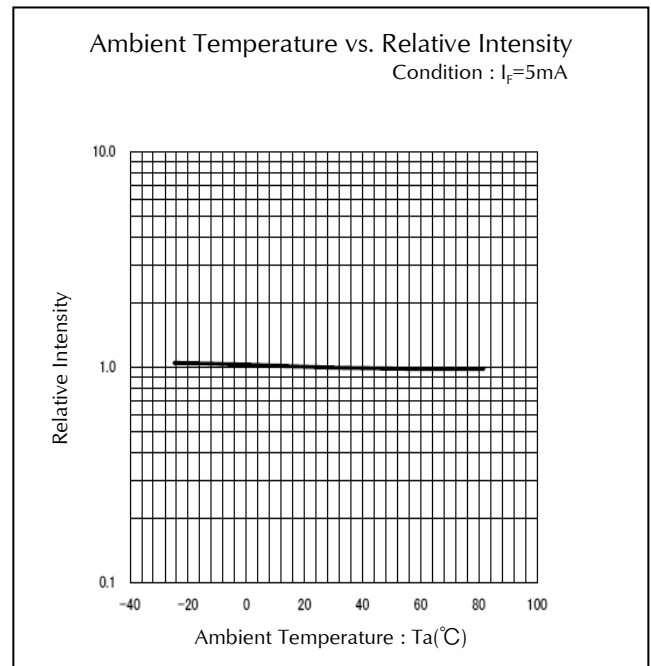
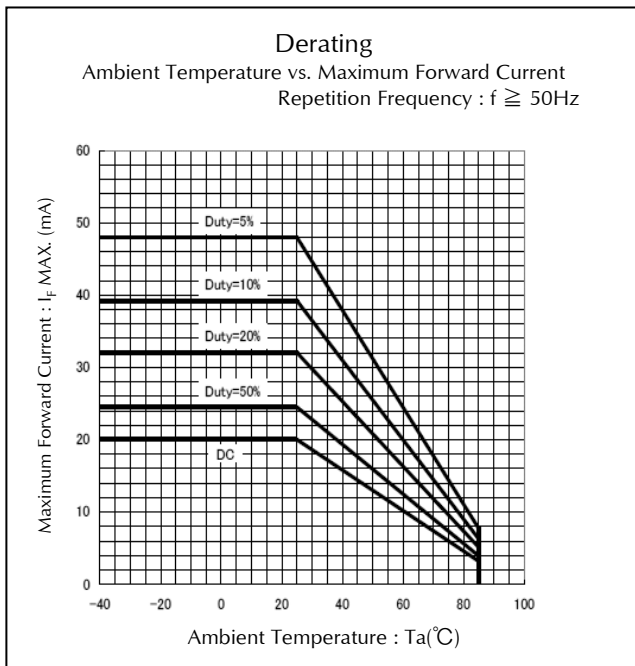
Rank	Dominant Wavelength λd (nm)			
	FY		FA	
	I _F =20mA		I _F =20mA	
	MIN.	MAX.	MIN.	MAX.
A	581.5	585.0	596.1	600.9
B	584.0	587.5	599.1	603.9
C	586.5	590.0	602.1	606.9
D	589.0	592.5	605.1	609.9
E	591.5	595.0	608.1	612.9
F	594.0	597.5		

Please contact our sales staff concerning rank designation.

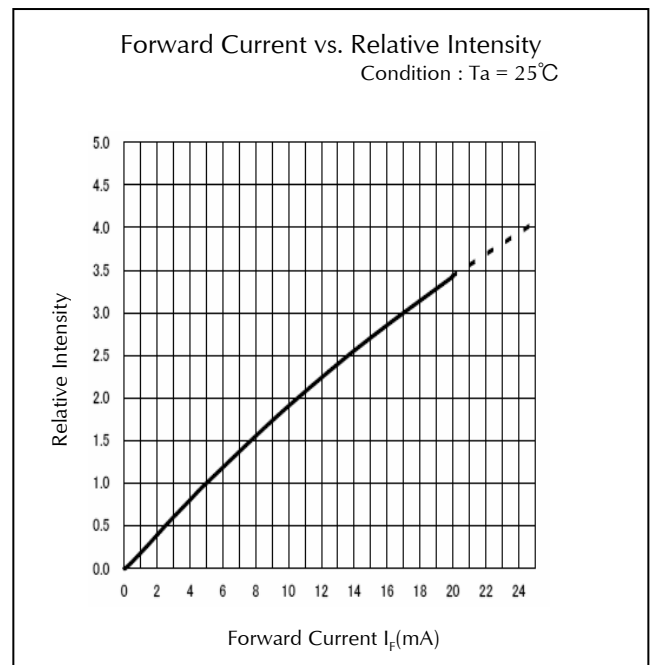
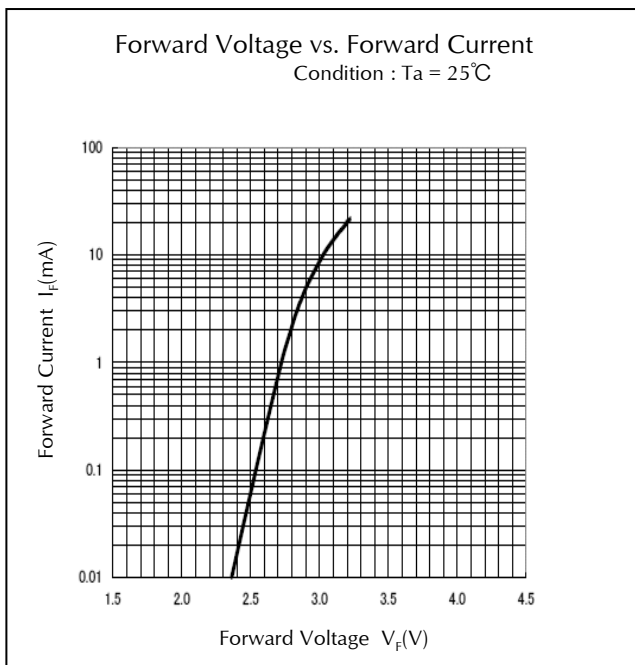
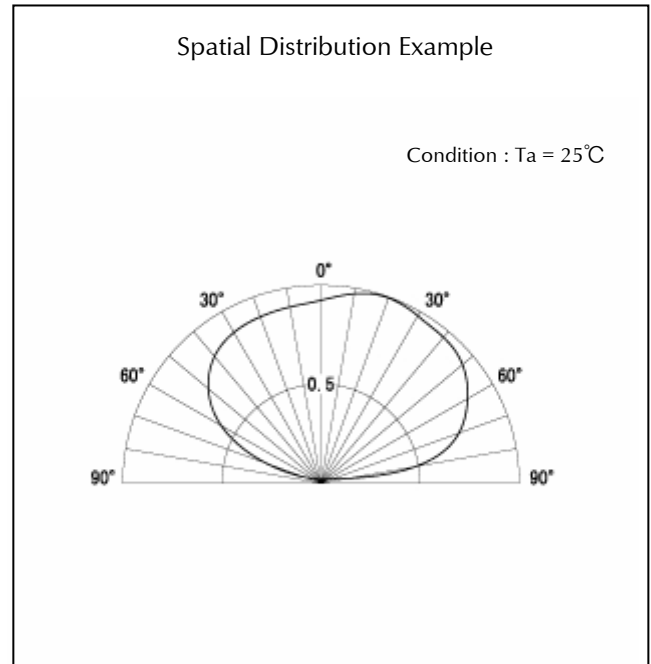
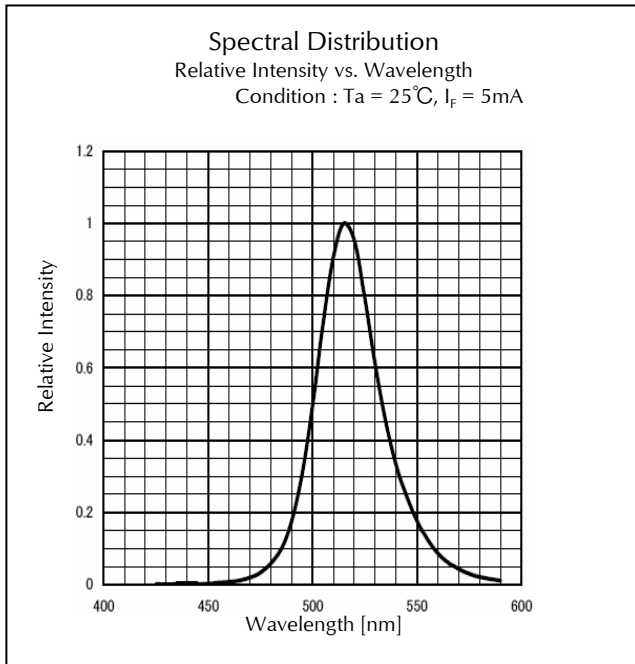
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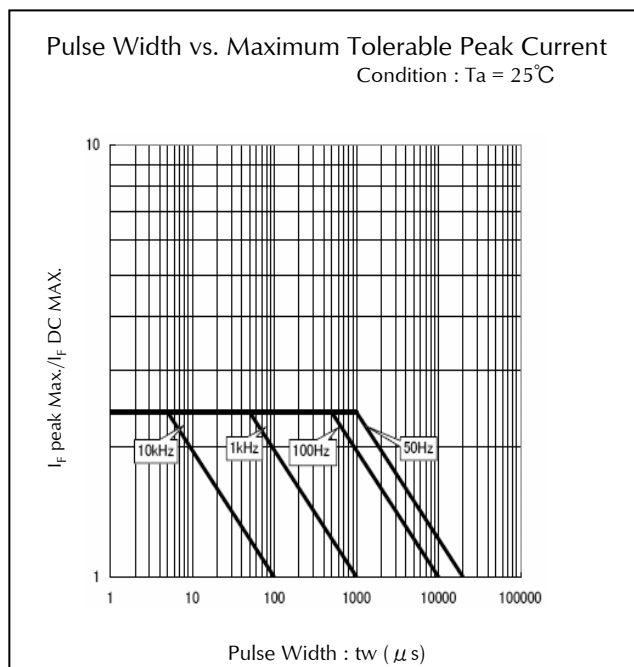
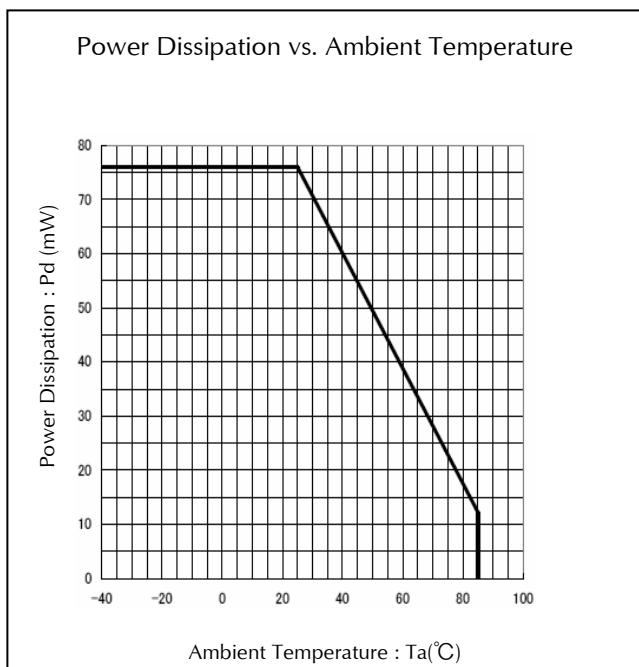
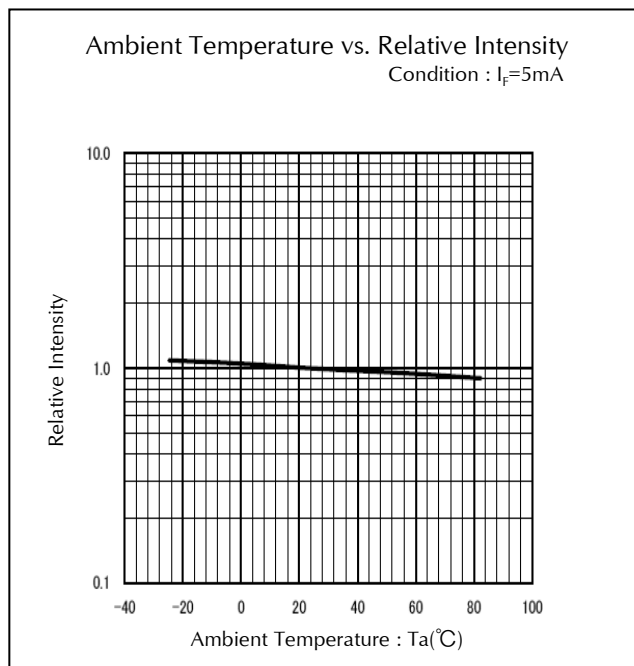
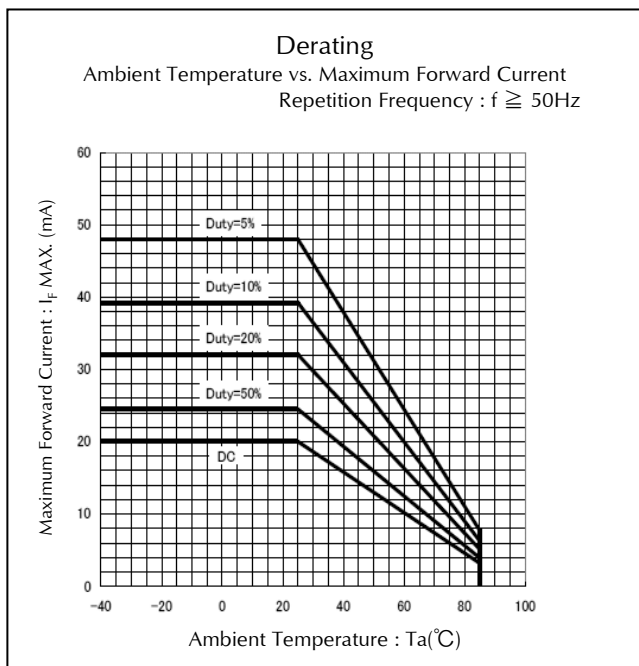
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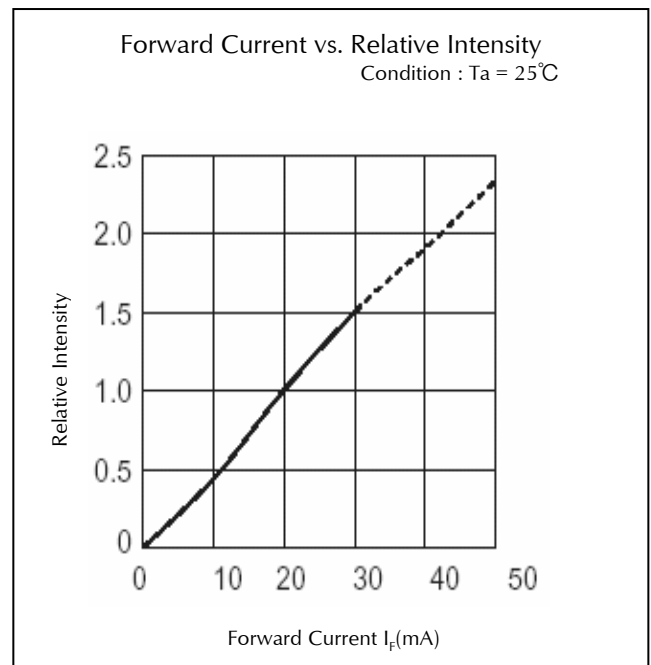
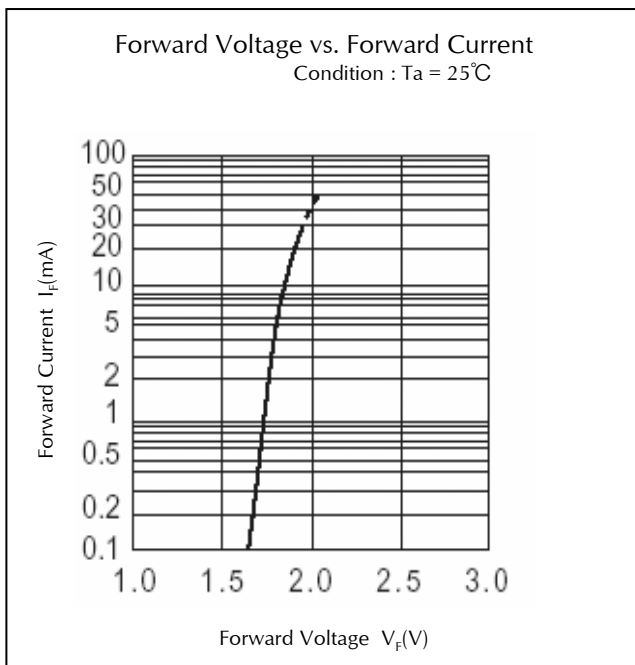
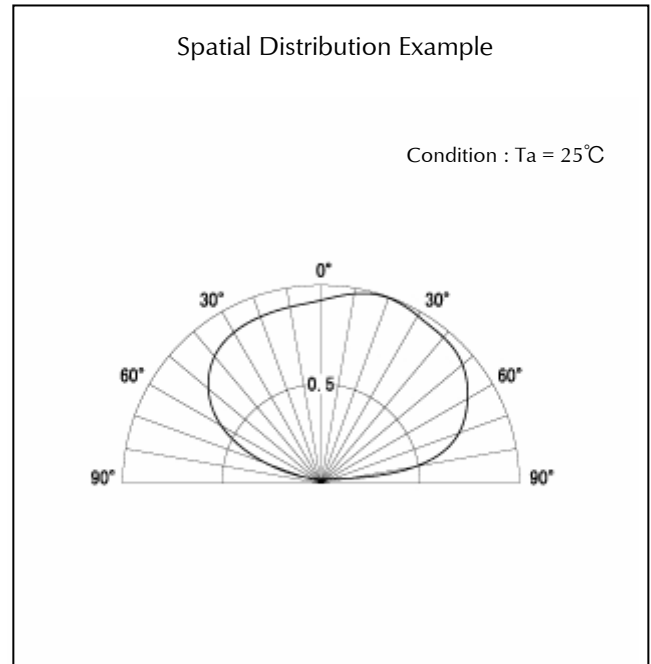
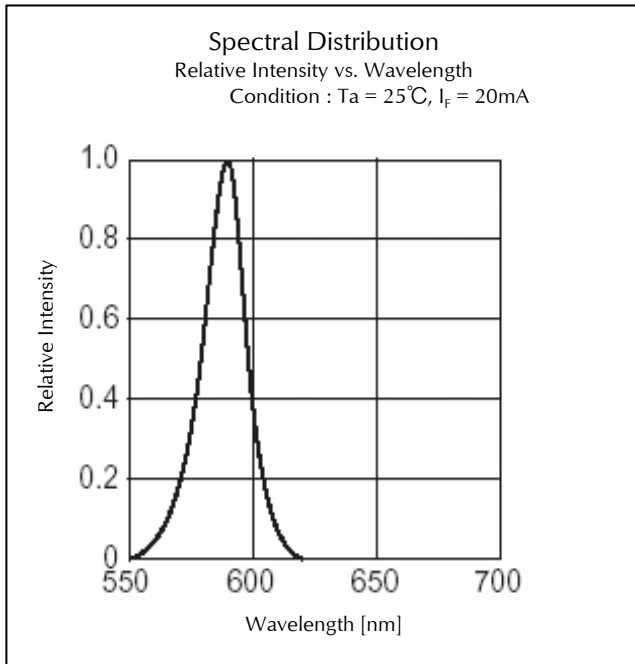
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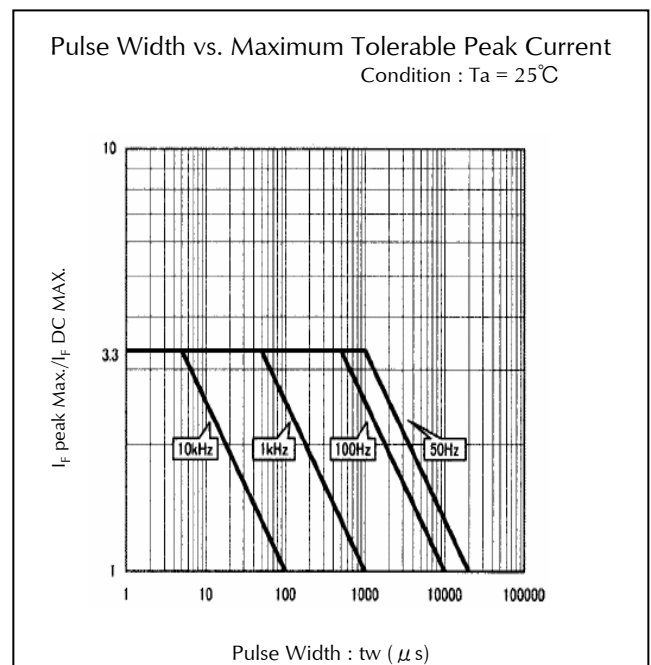
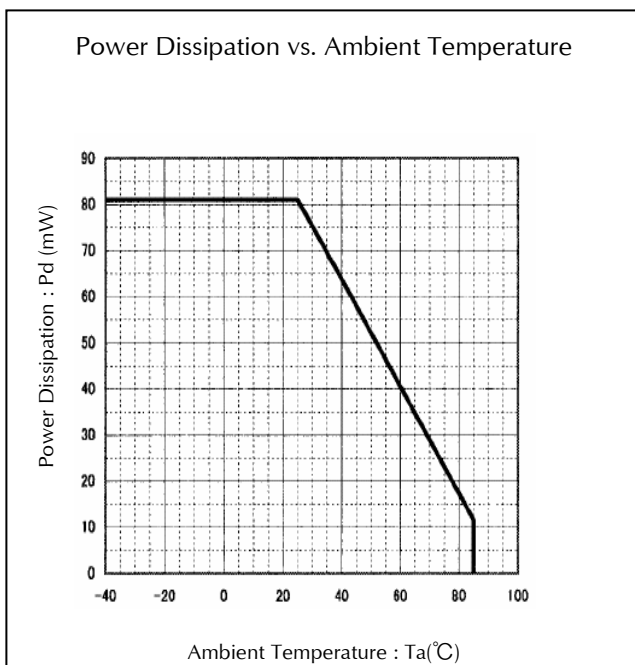
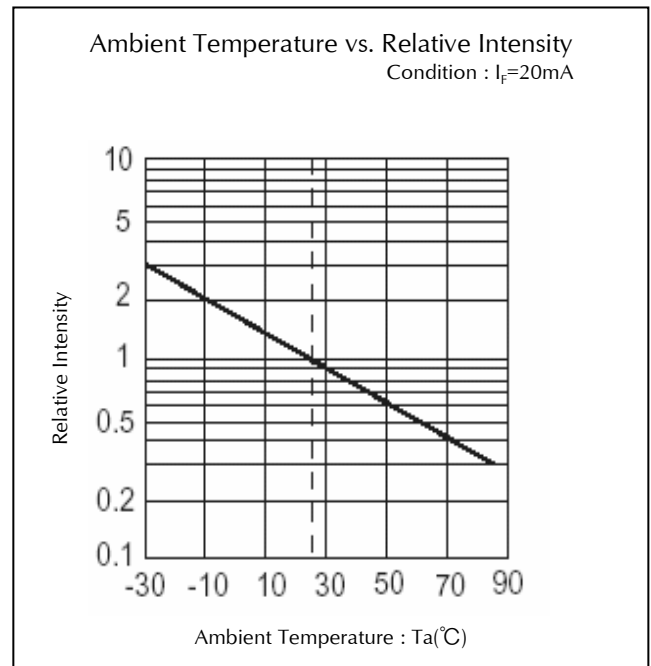
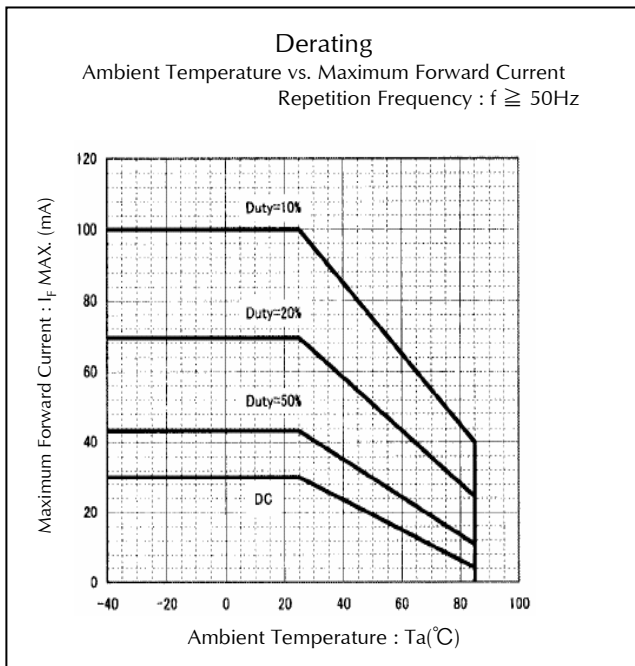
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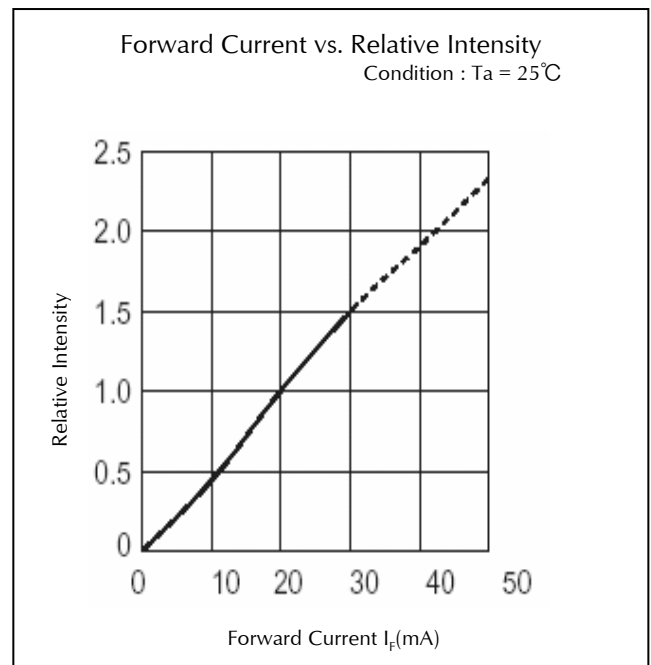
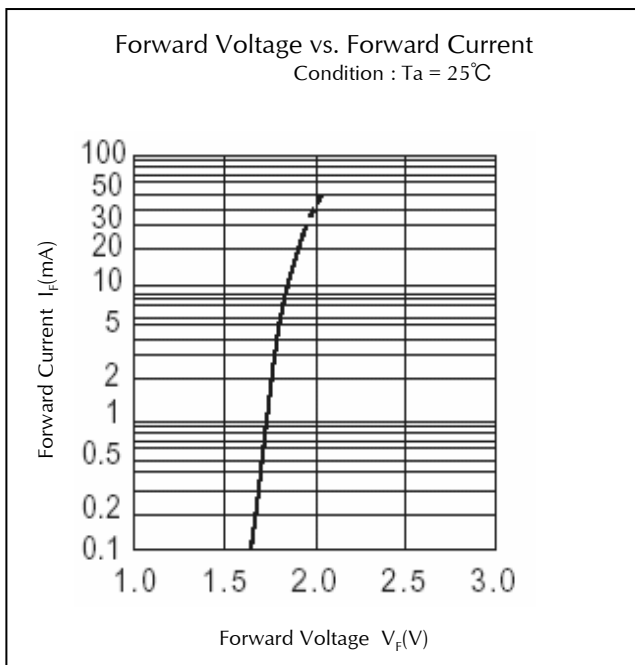
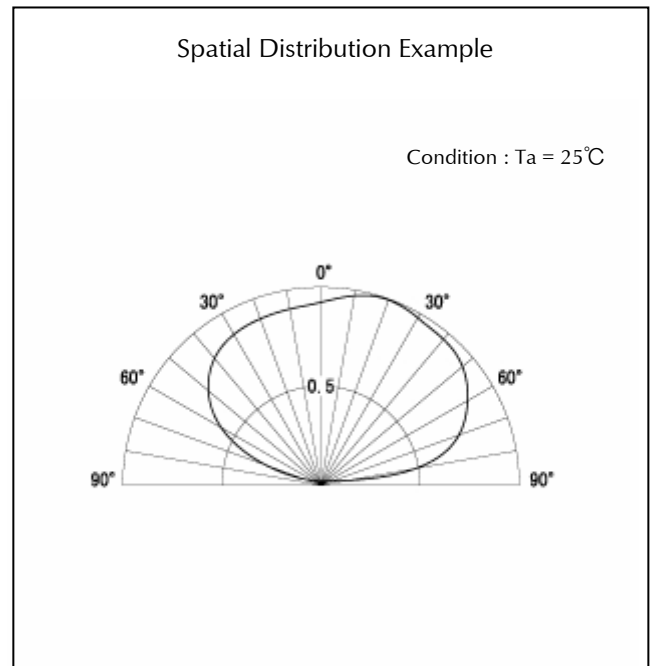
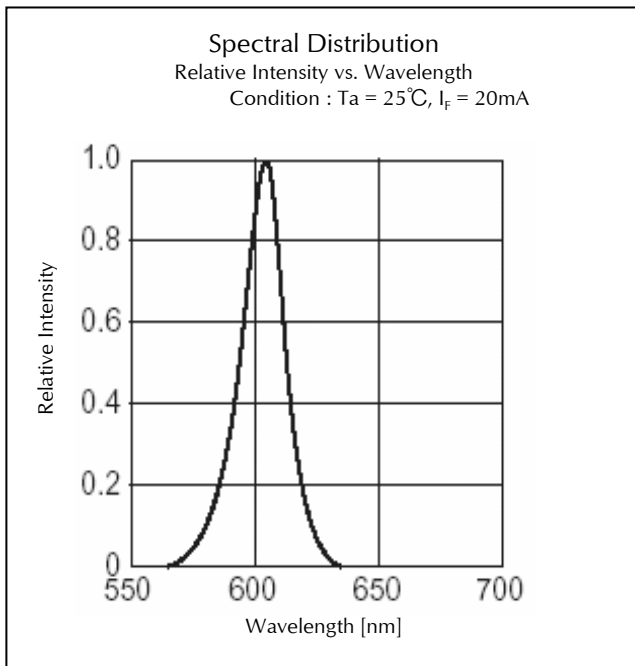
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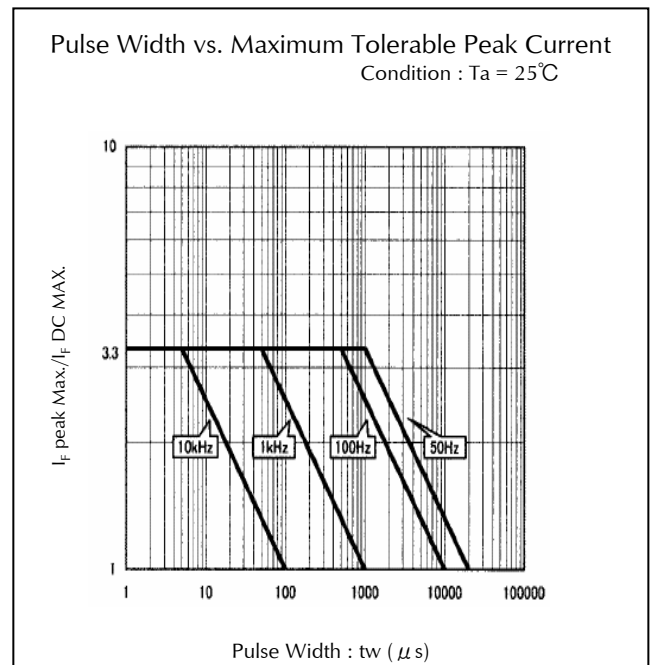
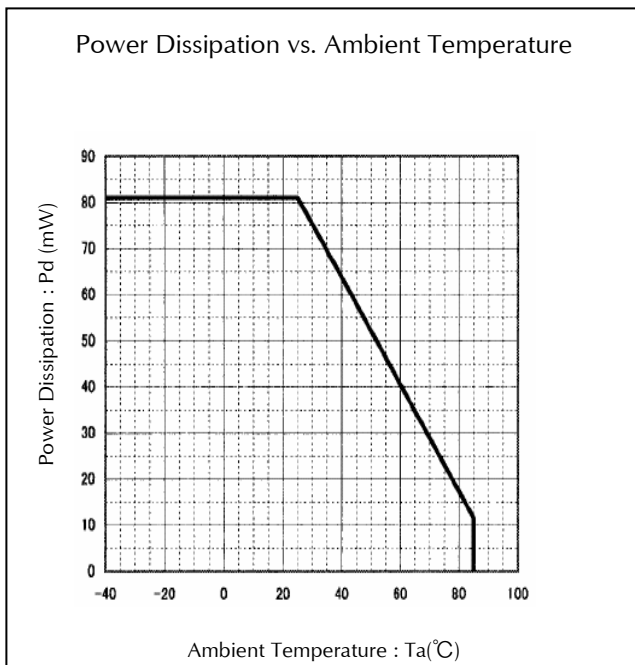
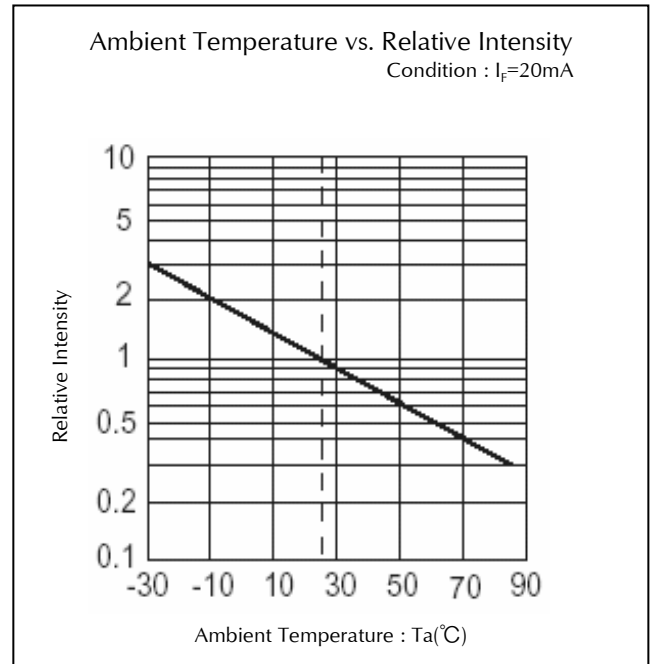
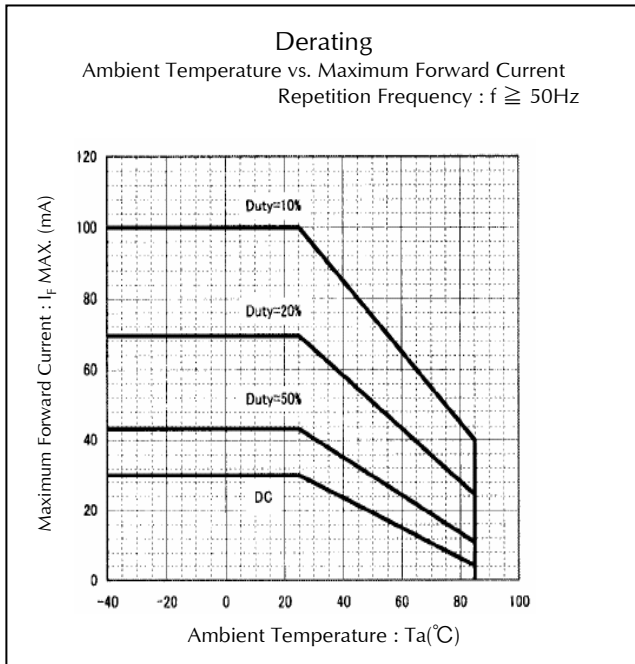
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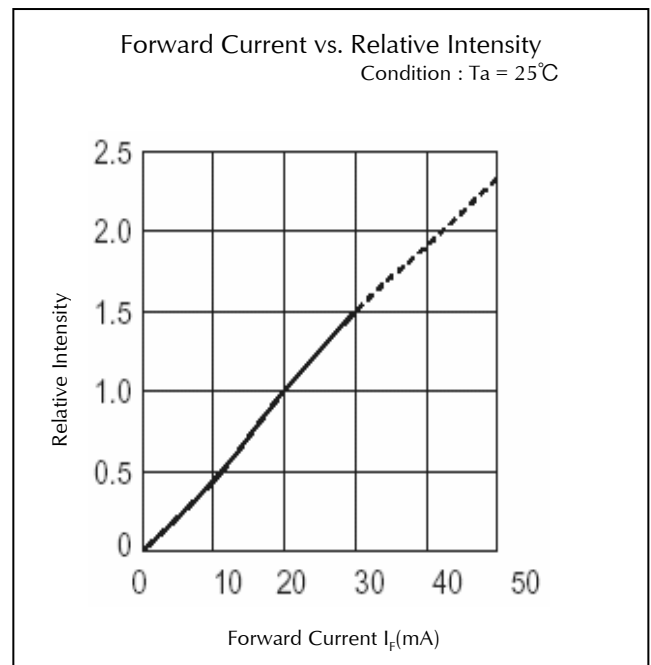
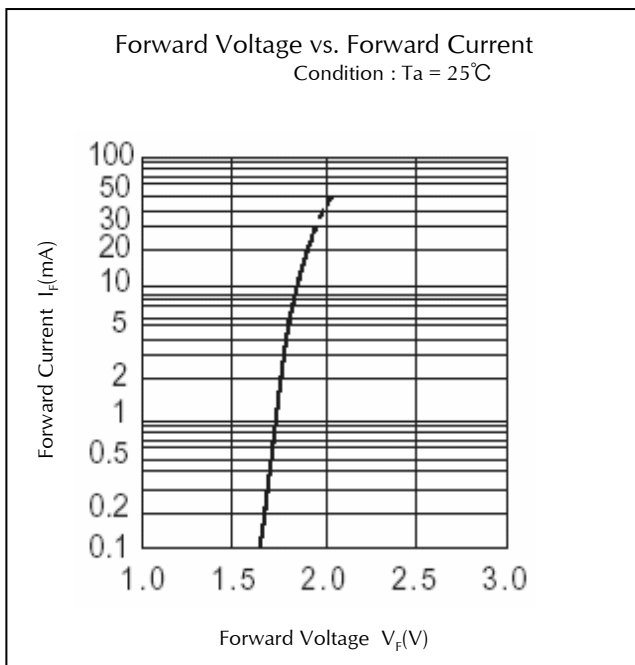
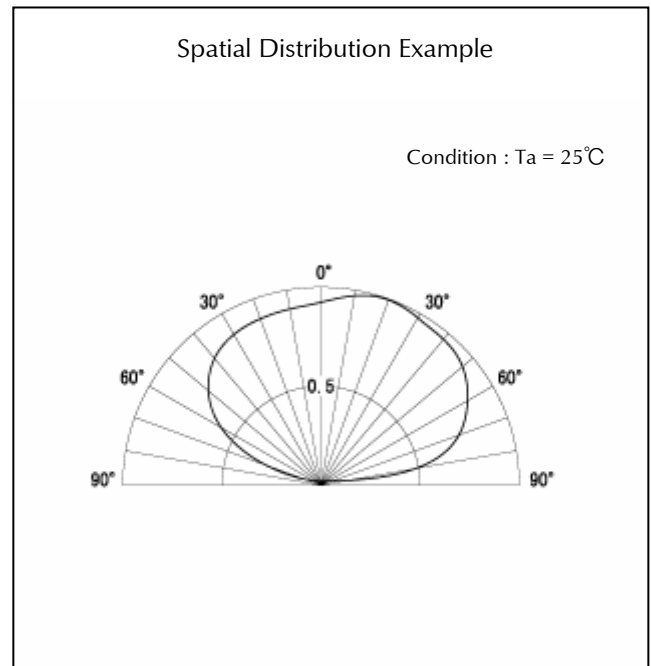
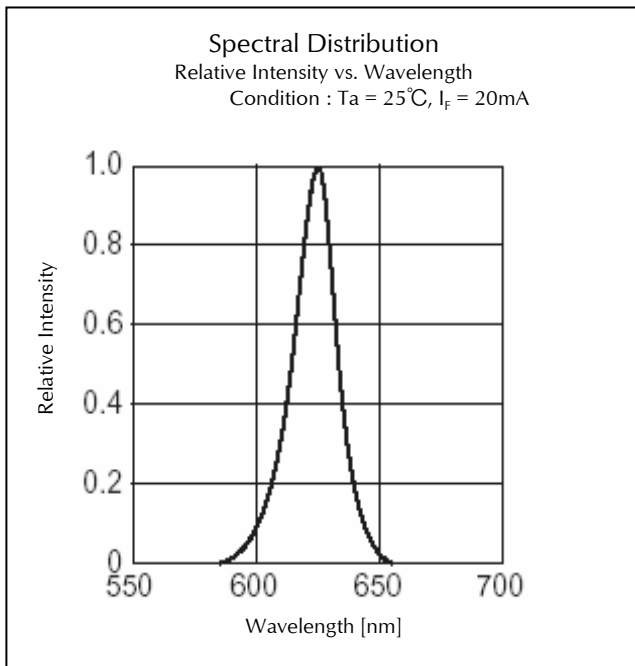
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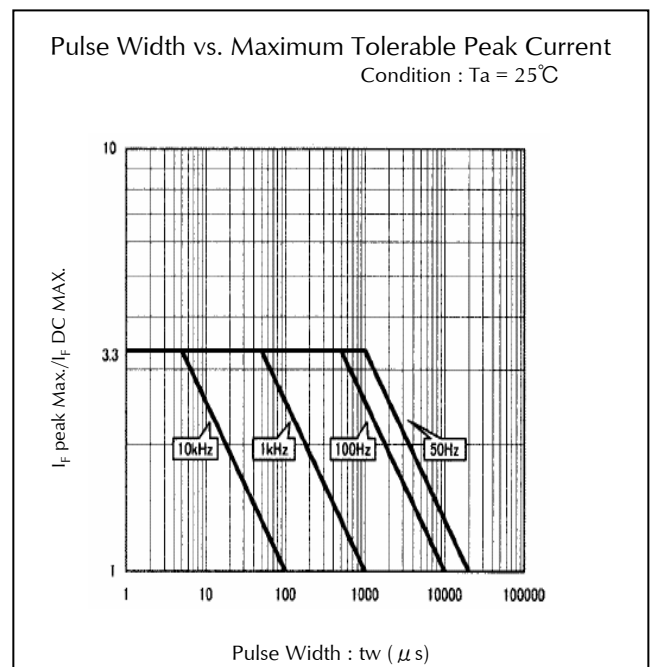
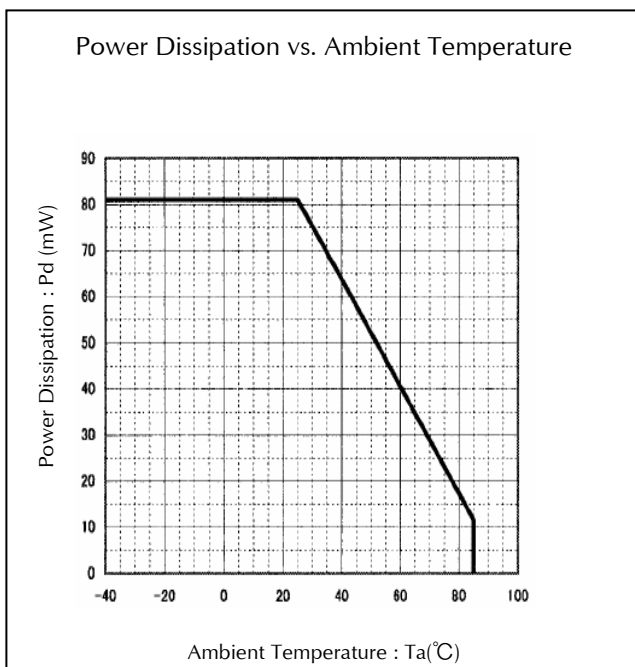
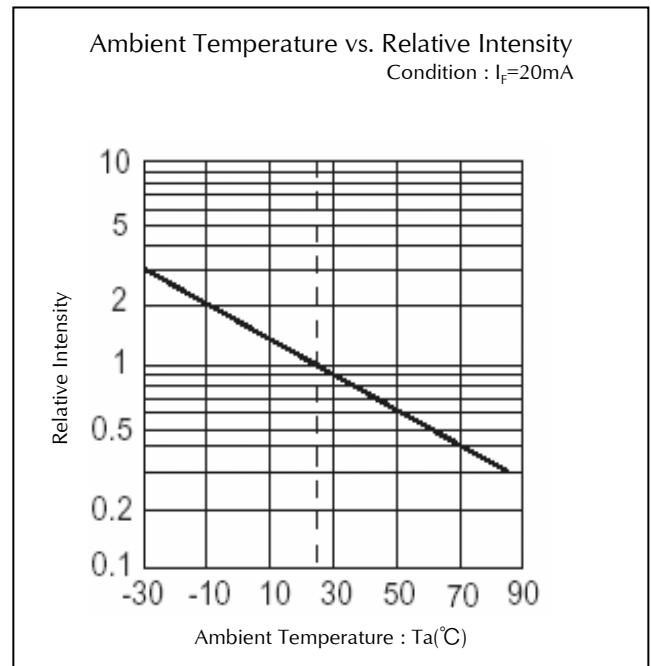
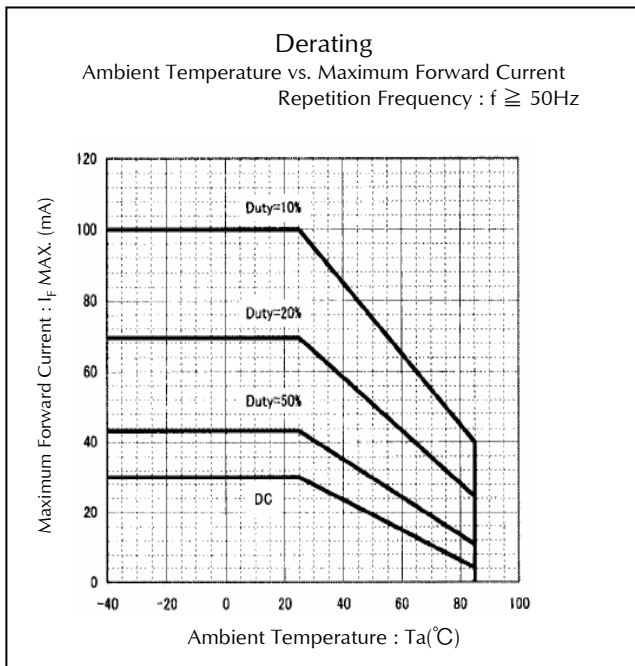
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Technical Data(FR)



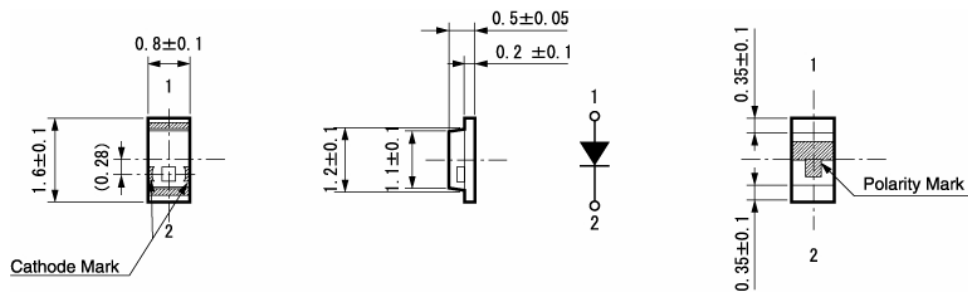
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Package Dimensions

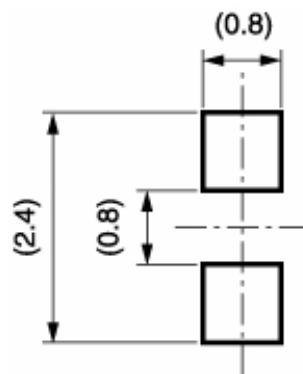
(Unit: mm)

Weight: (1.35)mg



Recommended Soldering Pattern

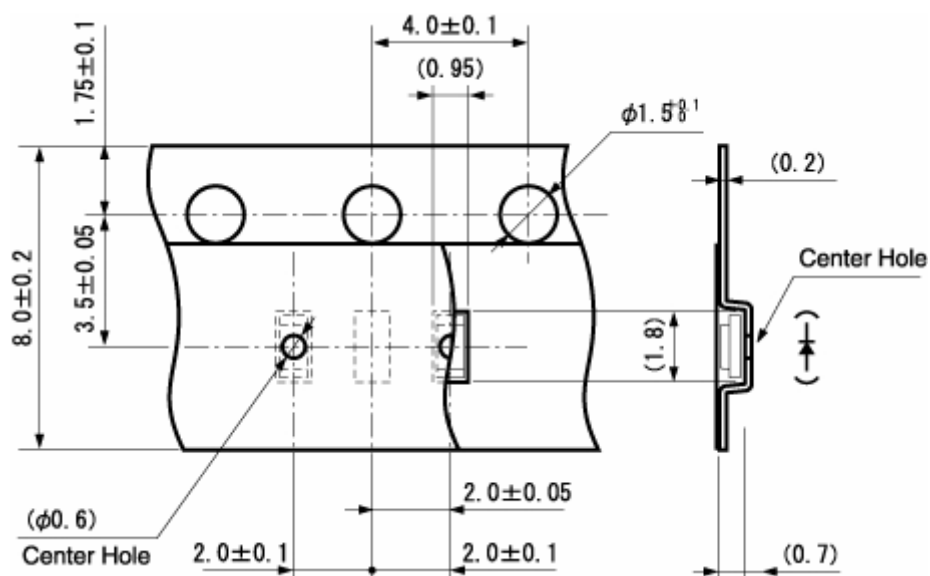
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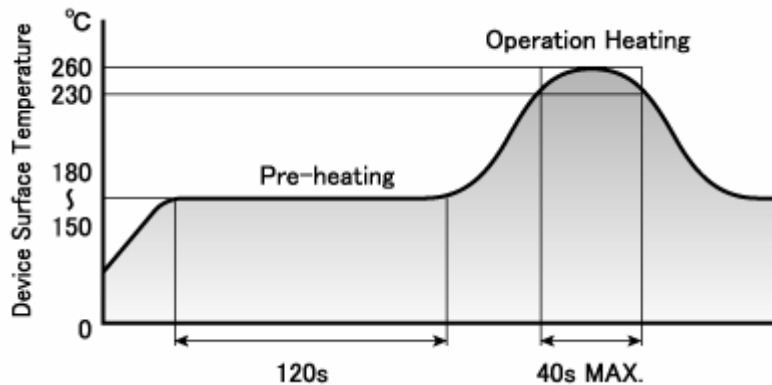
Taping Specification

(Unit: mm)

Quantity : 4,000pcs/ reel (standard)



Reflow Soldering Conditions



- 1) The above profile temperature gives the maximum temperature of the LED resin surface. Please set the temperature so as to avoid exceeding this range.
- 2) Total times of reflow soldering process shall be no more than 2 times. When the second reflow soldering process is performed, intervals between the first and second reflow should be short as possible (while allowing some time for the component to return to normal temperature after the first reflow) in order to prevent the LED from absorbing moisture.
- 3) Temperature fluctuation to the LED during the pre-heating process shall be minimized. (6°C maximum)

TTW (Through The Wave) soldering Conditions

Pre-heating	120 °C (MAX.) 60 s (MAX.)
Solder Bath Temp.	265 °C (MAX.)
Dipping Time	5 s (MAX.)

- 1) The dip soldering process shall be 2 times maximum.
- 2) The product shall be cooled to normal temperature before the second dipping process.

Manual Soldering Conditions

Iron tip temp.	350 °C (MAX.)
Soldering time and frequency	3 s (MAX.) 1 time (MAX.)

Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED-4701/100(101)	Ta = 25°C, If = Maximum Rated Current	1,000 h	0/25
Resistance to Soldering Heat	EIAJ ED-4701/300(302)	260±5°C	5sec	0/25
Temperature Cycling	EIAJ ED-4701/100(105)	Minimum Rated Storage Temperature(30min) ~Normal Temperature(15min) ~Maximum Rated Storage Temperature(30min) ~Normal Temperature(15min)	5 cycles	0/25
Wet High Temp. Storage Life	EIAJ ED-4701/100(103)	Ta = 60±2°C, RH = 90±5%	1,000 h	0/25
High Temp. Storage Life	EIAJ ED-4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/25
Low Temp. Storage Life	EIAJ ED-4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/25
Vibration, Variable Frequency	EIAJ ED-4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Luminous Intensity	Iv	If Value of each product Luminous Intensity	Testing Min. Value < Spec. Min. Value x 0.5
Forward Voltage	V _F	If Value of each product Forward Voltage	Testing Max. Value ≥ Spec. Max. Value x 1.2
Reverse Current	I _R	V _R = Maximum Rated Reverse Voltage V	Testing Max. Value ≥ Spec. Max. Value x 2.5
Cosmetic Appearance	-	-	No notable, decoloration, deformation and cracking

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